

High Temperature Silicon Carbide Power Schottky Diode

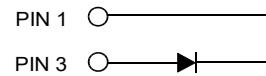
Features

- 650 V Schottky rectifier
- 210 °C maximum operating temperature
- Zero reverse recovery charge
- Superior surge current capability
- Positive temperature coefficient of V_F
- Temperature independent switching behavior
- Lowest figure of merit Q_c/I_F
- Available screened to Mil-PRF-19500

V_{RRM}	=	650 V
I_F ($T_C=25^\circ\text{C}$)	=	14 A
Q_c	=	20 nC

Package

- RoHS Compliant



SMD0.5 / TO – 276 (Hermetic Package)

Advantages

- High temperature operation
- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Industry's lowest reverse recovery charge
- Industry's lowest device capacitance
- Ideal for output switching of power supplies
- Best in class reverse leakage current at operating temperature

Applications

- Down Hole Oil Drilling
- Geothermal Instrumentation
- Solenoid Actuators
- General Purpose High-Temperature Switching
- Amplifiers
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)

Maximum Ratings at $T_j = 210^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	V_{RRM}		650	V
Continuous forward current	I_F	$T_C = 25^\circ\text{C}$	8	A
Continuous forward current	I_F	$T_C \leq 190^\circ\text{C}$	4.3	A
RMS forward current	$I_{F(RMS)}$	$T_C \leq 190^\circ\text{C}$	8	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_C = 25^\circ\text{C}, t_p = 10\text{ ms}$	32	A
Non-repetitive peak forward current	$I_{F,max}$	$T_C = 25^\circ\text{C}, t_p = 10\text{ }\mu\text{s}$	120	A
I^2t value	$\int I^2 dt$	$T_C = 25^\circ\text{C}, t_p = 10\text{ ms}$	5	A^2s
Power dissipation	P_{tot}	$T_C = 25^\circ\text{C}$	163	W
Operating and storage temperature	T_j, T_{stg}		-55 to 210	$^\circ\text{C}$

Electrical Characteristics at $T_j = 210^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode forward voltage	V_F	$I_F = 5\text{ A}, T_j = 25^\circ\text{C}$	1.7			V
		$I_F = 5\text{ A}, T_j = 210^\circ\text{C}$	2.9			
Reverse current	I_R	$V_R = 650\text{ V}, T_j = 25^\circ\text{C}$	1	5		μA
		$V_R = 650\text{ V}, T_j = 210^\circ\text{C}$	10	100		
Total capacitive charge	Q_c	$I_F \leq I_{F,MAX}$	20			nC
Switching time	t_s	$dI_F/dt = 200\text{ A}/\mu\text{s}$	274			
		$T_j = 210^\circ\text{C}$	< 25			ns
Total capacitance	C	$V_R = 1\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ\text{C}$	31			
		$V_R = 400\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ\text{C}$	29			pF
		$V_R = 650\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ\text{C}$				

Thermal Characteristics

Thermal resistance, junction - case	R_{thJC}	1.38	$^\circ\text{C/W}$
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Mechanical Properties

Mounting torque	M	0.6	Nm
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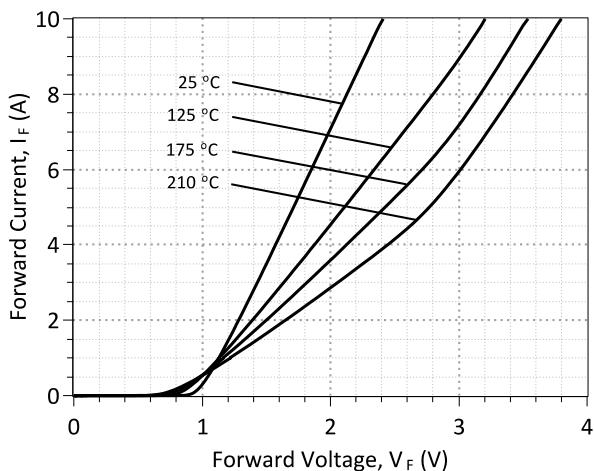


Figure 1: Typical Forward Characteristics

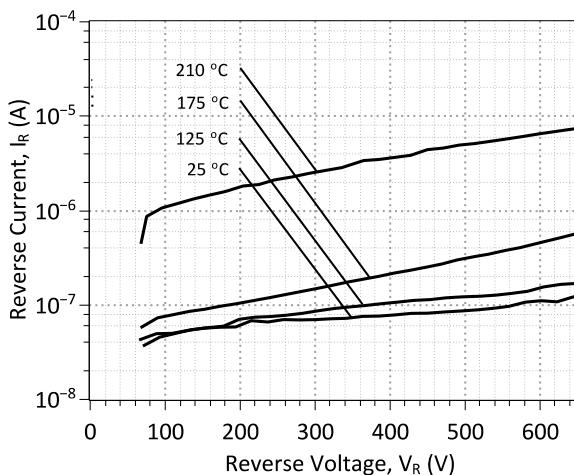


Figure 2: Typical Reverse Characteristics

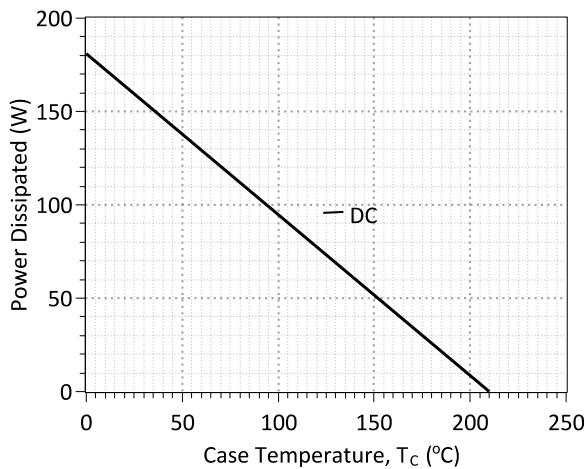


Figure 3: Power Derating Curve

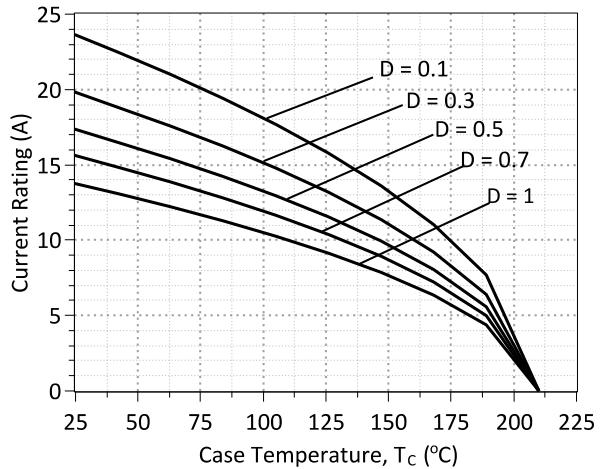


Figure 4: Current Derating Curves ($D = t_p/T$, $t_p = 400 \mu s$)
 (Considering worst case Z_{th} conditions)

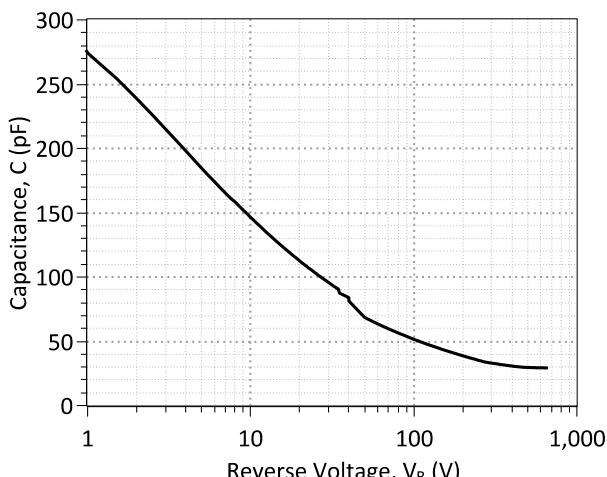


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

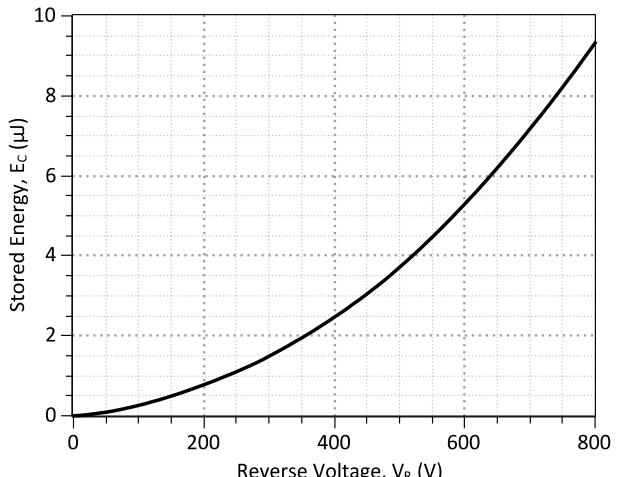


Figure 6: Typical Capacitive Energy vs Reverse Voltage Characteristics

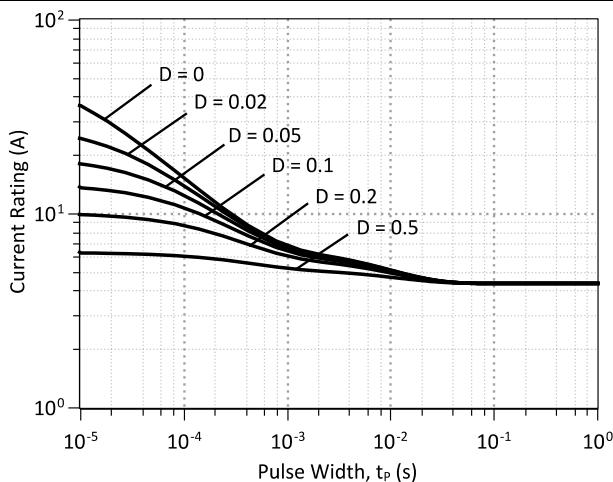


Figure 7: Current vs Pulse Duration Curves at $T_c = 190 \text{ } ^\circ\text{C}$

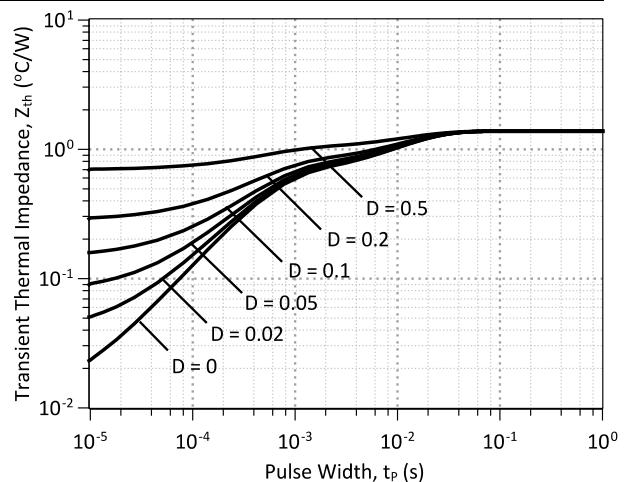
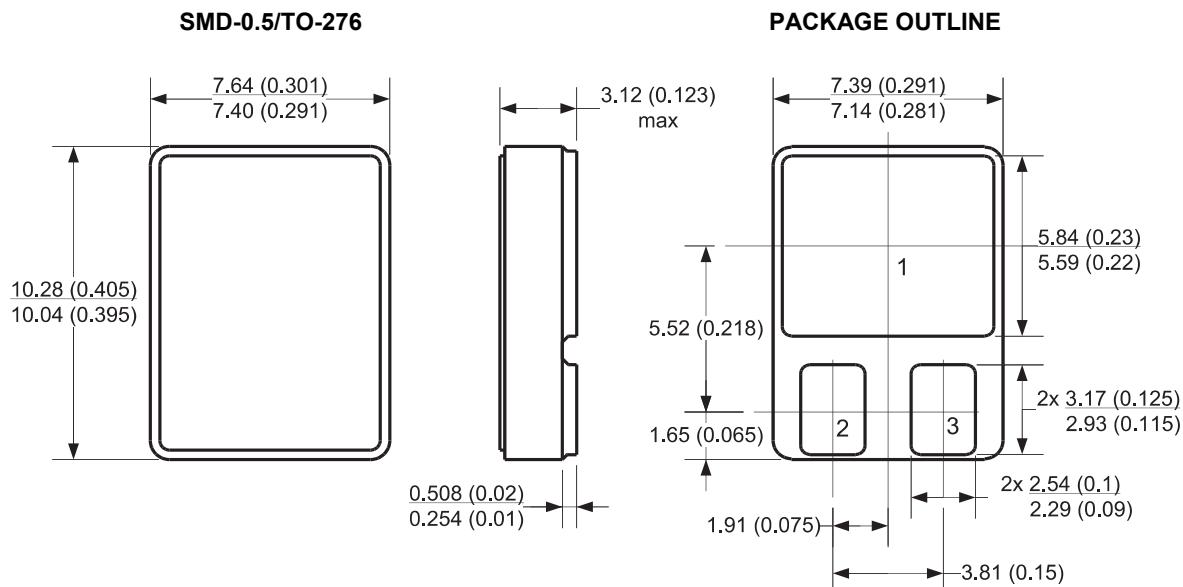


Figure 8: Transient Thermal Impedance

Package Dimensions:



NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

Revision History			
Date	Revision	Comments	Supersedes
2014/08/26	1	Updated Electrical Characteristics	
2012/04/24	0	Initial release	

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SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the 1N8033-GA device.

```
* MODEL OF GeneSiC Semiconductor Inc.  
*  
* $Revision: 1.0      $  
* $Date: 05-SEP-2013 $  
*  
* GeneSiC Semiconductor Inc.  
* 43670 Trade Center Place Ste. 155  
* Dulles, VA 20166  
* http://www.genesicsemi.com/index.php/hit-sic/schottky  
*  
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*  
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY  
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED  
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A  
* PARTICULAR PURPOSE."  
* Models accurate up to 2 times rated drain current.  
*  
* Start of 1N8033-GA SPICE Model  
*.SUBCKT 1N8033 ANODE KATHODE  
D1 ANODE KATHODE 1N8033_25C; Call the Schottky Diode Model  
D2 ANODE KATHODE 1N8033_PIN; Call the PiN Diode Model  
.MODEL 1N8033_25C D  
+ IS      1.99E-17      RS      0.12463  
+ N       1              IKF     569.082  
+ EG      1.2            XTI     3  
+ TRS1    0.0035        TRS2    3.87E-05  
+ CJO     3.38E-10      VJ      0.41772  
+ M       1.5479         FC      0.5  
+ TT      1.00E-10       BV      650  
+ IBV    1.00E-03       VPK     650  
+ IAVE    5              TYPE    Sic_Schottky  
+ MFG     GeneSiC_Semiconductor  
.MODEL 1N8033_PIN D  
+ IS      1.33E-10      RS      0.31147  
+ N       5              IKF     0  
+ EG      3.23           XTI     -10  
+ FC      0.5            TT      0  
+ BV      650            IBV    1.00E-03  
+ VPK    650            IAVE    5  
+ TYPE   Sic_Pin  
.ENDS  
*  
* End of 1N8033-GA SPICE Model
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